VS-ST730CL Series

Vishay Semiconductors



Phase Control Thyristors (Hockey PUK Version), 990 A



TO-200AC (B-PUK)

PRODUCT	PRODUCT SUMMARY					
Package	TO-200AC (B-PUK)					
Diode variation	Single SCR					
I _{T(AV)}	990 A					
V _{DRM} /V _{RRM}	800 V, 1200 V, 1400 V, 1600 V, 1800 V, 2000 V					
V _{TM}	1.62 V					
I _{GT}	100 mA					
TJ	-40 °C to 125 °C					

FEATURES

- Center amplifying gate
- Metal case with ceramic insulator
- International standard case TO-200AC (B-PUK)
- Designed and qualified for industrial level
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

- DC motor controls
- Controlled DC power supplies
- AC controllers

MAJOR RATINGS AND CHARACTERISTICS						
PARAMETER	TEST CONDITIONS	VALUES	UNITS			
I		990	А			
I _{T(AV)}	T _{hs}	55	°C			
1		2000	А			
I _T (RMS)	T _{hs}	25	°C			
1	50 Hz	17 800	٨			
I _{TSM}	60 Hz	18 700	A			
l ² t	50 Hz	1591	kA ² s			
1-1	60 Hz	1452	KA-S			
V _{DRM} /V _{RRM}		800 to 2000	V			
t _q	Typical	150	μs			
TJ		-40 to 125	°C			

VOLTAGE RATINGS								
TYPE NUMBER	VOLTAGE CODE	V _{DRM} /V _{RRM} , MAXIMUM REPETITIVE PEAK AND OFF-STATE VOLTAGE V		$I_{DRM}/I_{RRM} MAXIMUM AT T_J = T_J MAXIMUM mA$				
	08	800	900					
	12	1200	1300					
VS-ST730CL	14	1400	1500	80				
V3-31730CL	16	1600	1700	00				
	18	1800	1900					
	20	2000	2100					

Revision: 15-Apr-14

1

Document Number: 94414

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COMPLIANT

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ABSOLUTE MAXIMUM RATING	5					
PARAMETER	SYMBOL	TEST CONDITIONS			VALUES	UNITS
Maximum average on-state current	L	180° condu	ction, half sine	wave	990 (375)	А
at heatsink temperature	I _{T(AV)}	double side	(single side) co	oled	55 (85)	°C
Maximum RMS on-state current	I _{T(RMS)}	DC at 25 °C	heatsink temp	erature double side cooled	2000	
		t = 10 ms	No voltage		17 800	
Maximum peak, one-cycle	L	t = 8.3 ms	reapplied		18 700	A kA ² s
non-repetitive surge current	I _{TSM}	t = 10 ms	100 % V _{RRM}		15 000	
		t = 8.3 ms	reapplied	Sinusoidal half wave,	15 700	
Maximum I ² t for fusing		t = 10 ms	No voltage reapplied	initial $T_J = T_J$ maximum	1591	
	l ² t	t = 8.3 ms			1452	
Maximum Frior fusing		t = 10 ms	100 % V _{RRM}		1125	
		t = 8.3 ms	reapplied		1027	
Maximum I ² \sqrt{t} for fusing	l²√t	t = 0.1 to 10) ms, no voltage	e reapplied	15 910	kA²√s
Low level value of threshold voltage	V _{T(TO)1}	(16.7 % x π	$x \ I_{T(AV)} < I < \pi \ x$	$I_{T(AV)}$), $T_J = T_J$ maximum	0.98	v
High level value of threshold voltage	V _{T(TO)2}	$(I > \pi \times I_{T(AV)})$	$(I > \pi \times I_{T(AV)}), T_J = T_J maximum$			v
Low level value of on-state slope resistance	r _{t1}	(16.7 % x π x $I_{T(AV)}$ < I < π x $I_{T(AV)}$), T _J = T _J maximum			0.32	mΩ
High level value of on-state slope resistance	r _{t2}	$(I > \pi \times I_{T(AV)}), T_J = T_J maximum$			0.27	11152
Maximum on-state voltage	V _{TM}	I_{pk} = 2000 A, T_J = T_J maximum, t_p = 10 ms sine pulse			1.62	V
Maximum holding current	Ι _Η	T 25 °C	T _J = 25 °C, anode supply 12 V resistive load			mA
Typical latching current	١ _L	ıj – 25 O,			1000	

SWITCHING				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum non-repetitive rate of rise of turned-on current	dl/dt	Gate drive 20 V, 20 $\Omega, t_r \leq 1 \; \mu s$ $T_J = T_J$ maximum, anode voltage $\leq 80 \; \% \; V_{DRM}$	1000	A/µs
Typical delay time	t _d	Gate current 1 A, dl _g /dt = 1 A/ μ s V _d = 0.67 % V _{DRM} , T _J = 25 °C	1.0	
Typical turn-off time	tq	I_{TM} = 750 A, T_J = T_J maximum, dl/dt = 60 A/µs, V_R = 50 V, dV/dt = 20 V/µs, gate 0 V 100 $\Omega,$ t_p = 500 µs	150	μs

BLOCKING								
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS				
Maximum critical rate of rise of off-state voltage	dV/dt	$T_J = T_J$ maximum linear to 80 % rated V_{DRM}	500	V/µs				
Maximum peak reverse and off-state leakage current	I _{RRM} , I _{DRM}	$T_J = T_J$ maximum, rated V_{DRM}/V_{RRM} applied	80	mA				

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TRIGGERING							
PARAMETER	SYMBOL	TEST CONDITIONS			VALUES		
	STNIBOL	TE,	TEST CONDITIONS			UNITS	
Maximum peak gate power	P _{GM}	$T_J = T_J$ maximum,	$t_p \le 5 ms$	10	0.0	w	
Maximum average gate power	P _{G(AV)}	$T_J = T_J$ maximum,	f = 50 Hz, d% = 50	2	.0	vv	
Maximum peak positive gate current	I _{GM}	$T_J = T_J$ maximum,	$t_p \le 5 ms$	3	.0	А	
Maximum peak positive gate voltage	$+ V_{GM}$		t < 5 mg	20		v	
Maximum peak negative gate voltage	- V _{GM}	$T_J = T_J$ maximum, $t_p \le 5$ ms		5.0		v	
		T _J = -40 °C	Maximum required gate trigger/ current/voltage are the lowest	200	-		
DC gate current required to trigger	I _{GT}	T _J = 25 °C		100	200	mA	
		T _J = 125 °C		50	-		
		T _J = -40 °C	value which will trigger all units	2.5	-		
DC gate voltage required to trigger	V_{GT}	T _J = 25 °C	12 V anode to cathode applied	1.8	3.0	V	
		T _J = 125 °C		1.1	-		
DC gate current not to trigger	I _{GD}		Maximum gate current/voltage not to trigger is the maximum	1	0	mA	
DC gate voltage not to trigger	V _{GD}	$T_J = T_J$ maximum	value which will not trigger any unit with rated V _{DRM} anode to cathode applied	0.25		V	

THERMAL AND MECHANICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum operating junction temperature range	TJ		-40 to 125	℃	
Maximum storage temperature range	T _{Stg}		-40 to 150		
Maximum thermal registerion, junction to heataink	Р	DC operation single side cooled	0.073		
Maximum thermal resistance, junction to heatsink	R _{thJ-hs}	DC operation double side cooled	0.031	к/w	
Maximum thermal registeres, sees to besteink	R _{thC-hs}	DC operation single side cooled	0.011	- r., vv	
Maximum thermal resistance, case to heatsink		DC operation double side cooled	0.006		
Mounting force, ± 10 %			14 700 (1500)	N (kg)	
Approximate weight			255	g	
Case style		See dimensions - link at the end of datasheet	TO-200AC (B-PUK)	

CONDUCTION ANGLE	SINUSOIDAL CONDUCTION		RECTANGULAR CONDUCTION		TEST CONDITIONS	
CONDUCTION ANGLE	SINGLE SIDE	DOUBLE SIDE	SINGLE SIDE	DOUBLE SIDE	TEST CONDITIONS	UNITS
180°	0.009	0.009	0.006	0.006		
120°	0.011	0.011	0.010	0.011		
90°	0.014	0.014	0.015	0.015	$T_J = T_J$ maximum	K/W
60°	0.020	0.020	0.021	0.021		
30°	0.036	0.036	0.036	0.036		

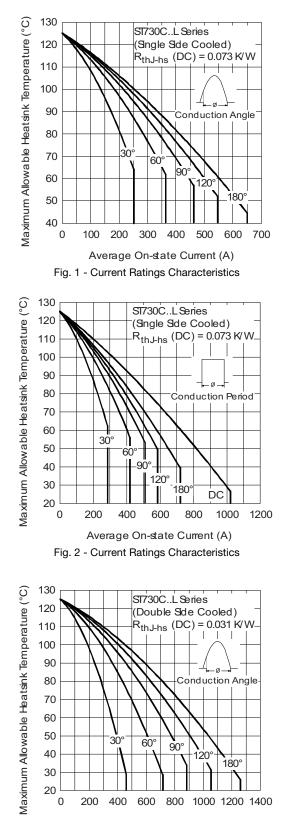
Note

The table above shows the increment of thermal resistance RthJ-hs when devices operate at different conduction angles than DC ٠

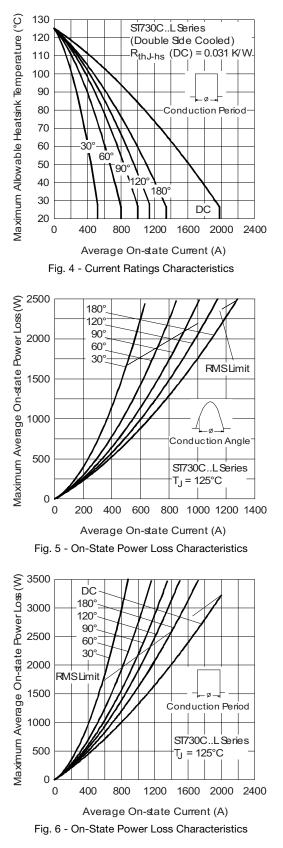
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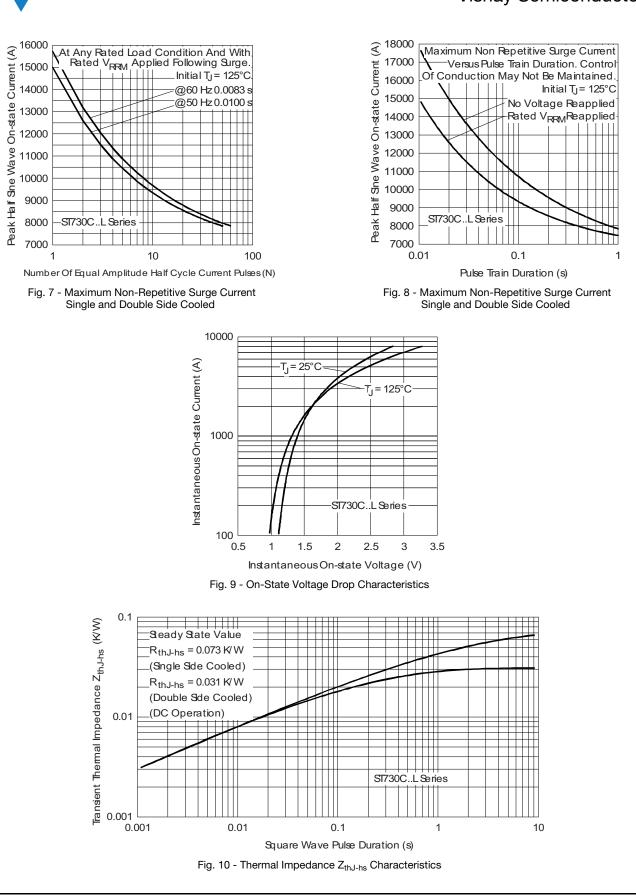
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4

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VS-ST730CL Series SHA www.vishay.com **Vishay Semiconductors** 100 Rectangulargate pulse (1) PGM = 10W, tp = 4ms (2) PGM = 20W, tp = 2ms(3) PGM = 40W, tp = 1msa) Recommended load line for \mp Instantaneous Gate Voltage (V)

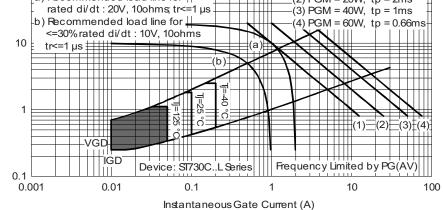


Fig. 11 - Gate Characteristics

ORDERING INFORMATION TABLE

LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95076			

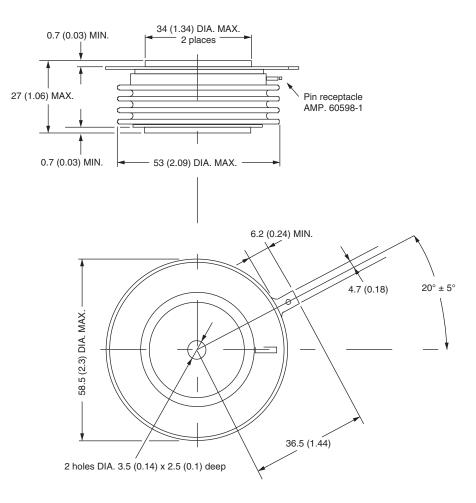


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DIMENSIONS in millimeters (inches)

Creepage distance: 36.33 (1.430) minimum Strike distance: 17.43 (0.686) minimum



Quote between upper and lower pole pieces has to be considered after application of mounting force (see thermal and mechanical specification)



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